#### **MAXIMUM RATINGS**

| Symbol               | Parameter   | Value                        | Unit |
|----------------------|---|------------------------------|------|
| V <sub>CC</sub>      | DC Supply Voltage (Referenced to GND)   | -0.5 to +7.0                 | V    |
| V <sub>IN</sub>      | DC Input Voltage (Referenced to GND)  | -0.5 to V <sub>CC</sub> +0.5 | V    |
| V <sub>OUT</sub>     | DC Output Voltage (Referenced to GND) (Note 1)  | -0.5 to V <sub>CC</sub> +0.5 | V    |
| I <sub>IK</sub>      | DC Input Diode Current  | ±20                          | mA   |
| I <sub>OK</sub>      | DC Output Diode Current   | ±50                          | mA   |
| I <sub>OUT</sub>     | DC Output Sink/Source Current   | ±50                          | mA   |
| I <sub>CC</sub>      | DC Supply Current, per Output Pin   | ±50                          | mA   |
| I <sub>GND</sub>     | DC Ground Current, per Output Pin   | ±100                         | mA   |
| T <sub>STG</sub>     | Storage Temperature Range   | -65 to +150                  | °C   |
| TL                   | Lead temperature, 1 mm from Case for 10 Seconds   | 260                          | °C   |
| TJ                   | Junction Temperature Under Bias   | 140                          | °C   |
| $\theta_{JA}$        | Thermal Resistance (Note 2)   | 65.8                         | °C/W |
| MSL                  | Moisture Sensitivity  | Level 1                      |      |
| F <sub>R</sub>       | Flammability Rating Oxygen Index: 30% – 35%   | UL 94 V-0 @ 0.125 in         |      |
| V <sub>ESD</sub>     | ESD Withstand Voltage  Human Body Model (Note 3)  Machine Model (Note 4)  Charged Device Model (Note 5) | > 2000<br>> 200<br>> 1000    | V    |
| I <sub>Latchup</sub> | Latchup Performance Above V <sub>CC</sub> and Below GND at 85°C (Note 6)                                | ±100                         | mA   |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. I<sub>OUT</sub> absolute maximum rating must be observed.
- The package thermal impedance is calculated in accordance with JESD 51-7.
- 3. Tested to EIA/JESD22-A114-A.
- 4. Tested to EIA/JESD22-A115-A.
- 5. Tested to JESD22-C101-A.
- 6. Tested to EIA/JESD78.

#### RECOMMENDED OPERATING CONDITIONS

| Symbol                             | Parameter   | Min    | Тур       | Max             | Unit |
|------------------------------------|---|--------|-----------|-----------------|------|
| V <sub>CC</sub>                    | DC Input Voltage (Referenced to GND)  | 4.5    |           | 5.5             | V    |
| V <sub>in</sub> , V <sub>out</sub> | DC Input Voltage, Output Voltage (Referenced to GND)                                    | 0      |           | V <sub>CC</sub> | V    |
| T <sub>A</sub>                     | Operating Temperature, All Package Types  | -40    | 25        | +85             | °C   |
| t <sub>r</sub> , t <sub>f</sub>    | Input Rise and Fall Time (Note 8) $ V_{CC} = 4.5 \text{ V} $ $ V_{CC} = 5.5 \text{ V} $ | 0<br>0 | 10<br>8.0 | 10<br>8.0       | ns/V |
| I <sub>OH</sub>                    | Output Current – High   |        |           | -24             | mA   |
| I <sub>OL</sub>                    | Output Current – Low  |        |           | 24              | mA   |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

7. Unused Inputs may not be left open. All inputs must be tied to a high voltage level or low logic voltage level.

- 8. V<sub>in</sub> from 0.8 V to 2.0 V; refer to individual Data Sheets for devices that differ from the typical input rise and fall times.

#### **DC CHARACTERISTICS**

|                                      |  | V <sub>CC</sub> | T <sub>A</sub> = - | +25°C                 | T <sub>A</sub> = -40°C to<br>+85°C |          |   |  |
|--------------------------------------|--|-----------------|--------------------|-----------------------|------------------------------------|----------|---|--|
| Symbol                               | Parameter                              | (V)             | Тур                | Typ Guaranteed Limits |                                    | Unit     | Conditions  |  |
| V <sub>IH</sub>                      | Minimum High Level Input Voltage       | 4.5<br>5.5      | 1.5<br>1.5         | 2.0<br>2.0            | 2.0<br>2.0                         | V<br>V   | V <sub>OUT</sub> = 0.1 V<br>or<br>V <sub>CC</sub> - 0.1 V   |  |
| V <sub>IL</sub>                      | Maximum Low Level Input Voltage        | 4.5<br>5.5      | 1.5<br>1.5         | 0.8<br>0.8            | 0.8<br>0.8                         | V<br>V   | V <sub>OUT</sub> = 0.1 V<br>or<br>V <sub>CC</sub> - 0.1 V   |  |
| V <sub>OH</sub>                      | Minimum High Level Output Voltage      | 4.5<br>5.5      | 4.49<br>5.49       | 4.4<br>5.4            | 4.4<br>5.4                         | V<br>V   | I <sub>OUT</sub> = -50 μA   |  |
|                                      |  | 4.5<br>5.5      |                    | 3.86<br>4.86          | 3.76<br>4.76                       | V<br>V   | $^*$ V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> $-24$ mA $^-$ 24 mA                                     |  |
| V <sub>OL</sub>                      | Maximum Low Level Output Voltage       | 4.5<br>5.5      | 0.001<br>0.001     | 0.1<br>0.1            | 0.1<br>0.1                         | V<br>V   | I <sub>OUT</sub> = 50 μA  |  |
|                                      |  | 4.5<br>5.5      |                    | 0.36<br>0.36          | 0.44<br>0.44                       | V<br>V   | $^*$ V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> $-24$ mA $^-$ 24 mA                                     |  |
| I <sub>IN</sub>                      | Maximum Input Leakage Current          | 5.5             |                    | ±0.1                  | ±1.0                               | μΑ       | $V_I = V_{CC}$ , GND  |  |
| $\Delta I_{CCT}$                     | Additional Max. I <sub>CC</sub> /Input | 5.5             | 0.6                |                       | 1.5                                | mA       | $V_{I} = V_{CC} - 2.1 \text{ V}$  |  |
| I <sub>OZ</sub>                      | Maximum 3–State Current                | 5.5             |                    | ±0.5                  | ±5.0                               | μΑ       | $ \begin{array}{c} V_{I}\left(OE\right) = V_{IL},V_{IH} \\ V_{I} = V_{CC},GND \\ V_{O} = V_{CC},GND \end{array} $ |  |
| I <sub>OLD</sub><br>I <sub>OHD</sub> | †Minimum Dynamic Output Current        | 5.5<br>5.5      |                    |                       | 75<br>–75                          | mA<br>mA | V <sub>OLD</sub> = 1.65 V Max   |  |
| Icc                                  | Maximum Quiescent Supply Current       | 5.5             |                    | 8.0                   | 80                                 | μΑ       | V <sub>IN</sub> = V <sub>CC</sub> or GND  |  |

<sup>\*</sup>All outputs loaded; thresholds on input associated with output under test. †Maximum test duration 2.0 ms, one output loaded at a time.

#### **AC CHARACTERISTICS** $t_r = t_f = 3.0$ ns (For Figures and Waveforms, See Figures 2 and 3.)

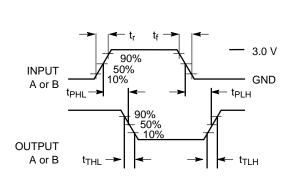
|                  |                     |                       |                          | T <sub>A</sub> = - | ⊦25°C<br>50 pF | T <sub>A</sub> = -40°C<br>C <sub>L</sub> = 5 | C to +85°C<br>50 pF |      |
|------------------|---------------------|-----------------------|--------------------------|--------------------|----------------|--|---------------------|------|
| Symbol           | Para                | ameter                | V <sub>CC</sub> *<br>(V) | Min                | Max            | Min  | Max                 | Unit |
| t <sub>PLH</sub> | Propagation Delay   | An to Bn or Bn to An  | 5.0                      | 1.5                | 8.0            | 1.0  | 8.5                 | ns   |
| t <sub>PHL</sub> | Propagation Delay   | An to Bn or Bn to An  | 5.0                      | 1.5                | 8.0            | 1.0  | 9.0                 | ns   |
| t <sub>PZH</sub> | Output Enable Time  | OE to An or Bn        | 5.0                      | 1.5                | 10.0           | 1.0  | 11.0                | ns   |
| t <sub>PZL</sub> | Output Enable Time  | OE to An or Bn        | 5.0                      | 1.5                | 10.0           | 1.0  | 11.0                | ns   |
| t <sub>PHZ</sub> | Output Disable Time | T/R or OE to An or Bn | 5.0                      | 1.5                | 10.0           | 1.0  | 11.0                | ns   |
| t <sub>PLZ</sub> | Output Disable Time | T/R or OE to An or Bn | 5.0                      | 1.5                | 10.0           | 1.0  | 11.0                | ns   |

<sup>\*</sup>Voltage Range 5.0 V is 5.0 V ±0.5 V

#### **CAPACITANCE**

| Symbol           | Parameter                     | Value Typ | Unit | Test Conditions         |
|------------------|-------------------------------|-----------|------|-------------------------|
| C <sub>IN</sub>  | Input Capacitance             | 4.5       | pF   | V <sub>CC</sub> = 5.0 V |
| C <sub>I/O</sub> | Input/Output Capacitance      | 15        | pF   | V <sub>CC</sub> = 5.0 V |
| C <sub>PD</sub>  | Power Dissipation Capacitance | 45        | pF   | V <sub>CC</sub> = 5.0 V |

#### **SWITCHING WAVEFORMS**



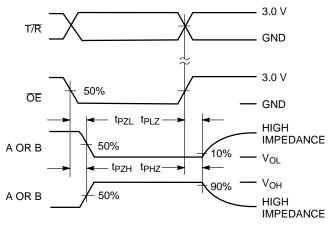
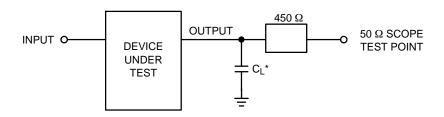


Figure 2.

Figure 3.



\*Includes all probe and jig capacitance

Figure 4. Test Circuit

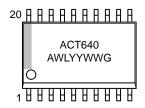
#### **ORDERING INFORMATION**

| Device          | Package              | Shipping <sup>†</sup> |  |
|-----------------|----------------------|-----------------------|--|
| MC74ACT640DWG   | SOIC-20<br>(Pb-Free) | 38 Units / Rail       |  |
| MC74ACT640DWR2G | SOIC-20<br>(Pb-Free) | 1000 / Tape & Reel    |  |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### **MARKING DIAGRAMS**

SOIC-20W



A = Assembly Location

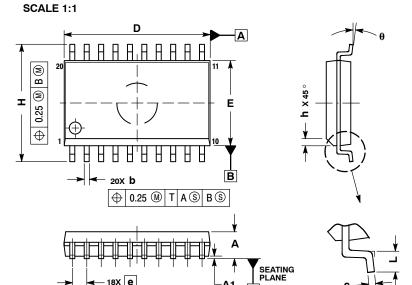
WL = Wafer Lot
 YY, Y = Year
 WW = Work Week
 G = Pb-Free Package





SOIC-20 WB CASE 751D-05 **ISSUE H** 

**DATE 22 APR 2015** 



- DIMENSIONS ARE IN MILLIMETERS.
   INTERPRET DIMENSIONS AND TOLERANCES.
- PER ASME Y14.5M, 1994.
  3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
  MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
- DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL

|     | MILLIMETERS |       |  |  |  |  |
|-----|-------------|-------|--|--|--|--|
| DIM | MIN         | MAX   |  |  |  |  |
| Α   | 2.35        | 2.65  |  |  |  |  |
| A1  | 0.10        | 0.25  |  |  |  |  |
| b   | 0.35        | 0.49  |  |  |  |  |
| С   | 0.23        | 0.32  |  |  |  |  |
| D   | 12.65       | 12.95 |  |  |  |  |
| E   | 7.40        | 7.60  |  |  |  |  |
| е   | 1.27 BSC    |       |  |  |  |  |
| Н   | 10.05       | 10.55 |  |  |  |  |
| h   | 0.25        | 0.75  |  |  |  |  |
| L   | 0.50        | 0.90  |  |  |  |  |
| A   | 0 °         | 7 °   |  |  |  |  |

#### **RECOMMENDED SOLDERING FOOTPRINT\***



DIMENSIONS: MILLIMETERS

#### **GENERIC MARKING DIAGRAM\***



XXXXX = Specific Device Code = Assembly Location

WL = Wafer Lot ΥY = Year WW = Work Week = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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